

## PATENT ASSIGNMENT COVER SHEET

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|---|-----------------------------|
| <b>SUBMISSION TYPE:</b>   | NEW ASSIGNMENT              |
| <b>NATURE OF CONVEYANCE:</b>  | ASSIGNMENT                  |
| <b>CONVEYING PARTY DATA</b>   |                             |
| <b>Name</b>   | <b>Execution Date</b>       |
| TUOMAS KÄRKKÄINEN   | 04/09/2019                  |
| OSSI KALEVO   | 04/10/2019                  |
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| <b>PROPERTY NUMBERS Total: 1</b>  |                             |
| <b>Property Type</b>  | <b>Number</b>               |
| Application Number:   | 15512265                    |
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| <b>SIGNATURE:</b>   | /gcz44004/                  |
| <b>DATE SIGNED:</b>   | 04/19/2019                  |
| <b>Total Attachments: 2</b>   |                             |
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| source=033US - Assignment SIGNED 04-2019_1#page2.tif  |                             |

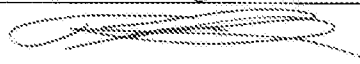
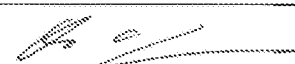


and any and all applications for patent or patents therefrom in any and all countries, including all divisions, continuations, and continuations-in-part, reexaminations, reissues and renewals thereof, and all benefits, rights of priority resulting from the filing of the application(s), and any and all Letters Patent of the United States, and countries foreign thereto, which may be granted or have granted for the Invention, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, unto the Company;

and I/we hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Letters Patent which may issue for the Invention to the Company, as assignee of the whole right, title and interest thereto;

and I/we further agree to, without any further consideration, communicate to the Company or its representatives or nominees any facts known to me/us respecting the Invention and improvements and testify in any legal proceeding, make all rightful oaths, sign and execute all necessary and lawful future documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights in all countries including but not limited to, any provisional, non-provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, for any derivation proceedings relating thereto, and, as to any patents that issue from such applications, for any supplemental examination, derivation proceeding, opposition, post grant review, reissue, re-examination, inter partes review, or extension thereof, and generally do everything possible to aid the Company, its successors, assigns and nominees, to obtain and enforce proper patent protection for the Invention and its improvements in all countries.

*Inventor(s) Signature(s)*

| <i>Name</i>              | <i>Signature</i>   | <i>Date</i> |
|--------------------------|--|-------------|
| <b>Tuomas KÄRKKÄINEN</b> |  | 2018-04-08  |
| <b>Ossi KALEVO</b>       |  | 10.4.2019   |